



| Dimensions | |
|------------|----------------|
| Footprint | 6032 |
| L | 6mm +/-0.3mm |
| W | 3.2mm +/-0.3mm |
| H | 2.5mm +/-0.3mm |
| S | 1.3mm +/-0.3mm |
| F | 2.2mm +/-0.1mm |
| K | 1.8mm TYP |

| Packaging Specifications | |
|--------------------------|------------|
| Packaging | T&R, 330mm |
| Packaging Quantity | 3000 |

| General Information | |
|---------------------|---|
| Series | B450 |
| Dielectric | MnO2 Tantalum |
| Style | SMD Chip |
| Description | SMD, Molded, Low ESR, Surge Robust |
| Features | Low ESR, Surge Robust |
| RoHS | Yes |
| Termination | Tin |
| AEC-Q200 | No |
| Notes | Obsolete. Old Part Number [Obsolete] Was B45010C2266M307. |

| Specifications | |
|-----------------------|--|
| Capacitance | 22 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 10 VDC (85C), 6.7 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 85°C |
| Dissipation Factor | 6% |
| Failure Rate | N/A |
| Resistance | 0.3 Ohms (100kHz) |
| Ripple Current | 610 mAmps (25C), 549 mAmps (85C), 244 mAmps (125C) |
| Leakage Current | 2.2 uA |

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